

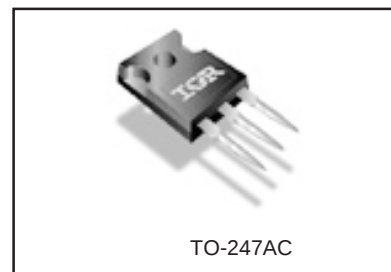
### Applications

- Switch Mode Power Supply (SMPS)
- Uninterruptible Power Supply
- High Speed Power Switching

| $V_{DSS}$ | $R_{DS(on)}$ max | $I_D$ |
|-----------|------------------|-------|
| 500V      | 0.23 $\Omega$    | 22A   |

### Benefits

- Low Gate Charge  $Q_g$  results in Simple Drive Requirement
- Improved Gate, Avalanche and Dynamic  $dv/dt$  Ruggedness
- Fully Characterized Capacitance and Avalanche Voltage and Current



### Absolute Maximum Ratings

|                                   | Parameter                                | Max.                   | Units               |
|-----------------------------------|------------------------------------------|------------------------|---------------------|
| $I_D$ @ $T_C = 25^\circ\text{C}$  | Continuous Drain Current, $V_{GS}$ @ 10V | 22                     | A                   |
| $I_D$ @ $T_C = 100^\circ\text{C}$ | Continuous Drain Current, $V_{GS}$ @ 10V | 14                     |                     |
| $I_{DM}$                          | Pulsed Drain Current ①                   | 88                     |                     |
| $P_D$ @ $T_C = 25^\circ\text{C}$  | Power Dissipation                        | 277                    | W                   |
|                                   | Linear Derating Factor                   | 2.2                    | W/ $^\circ\text{C}$ |
| $V_{GS}$                          | Gate-to-Source Voltage                   | $\pm 30$               | V                   |
| $dv/dt$                           | Peak Diode Recovery $dv/dt$ ③            | 4.8                    | V/ns                |
| $T_J$                             | Operating Junction and                   | -55 to + 150           | $^\circ\text{C}$    |
| $T_{STG}$                         | Storage Temperature Range                |                        |                     |
|                                   | Soldering Temperature, for 10 seconds    | 300 (1.6mm from case ) |                     |
|                                   | Mounting torque, 6-32 or M3 screw        | 10 lbf•in (1.1N•m)     |                     |

### Typical SMPS Topologies

- Full Bridge Converters
- Power Factor Correction Boost

# IRFP22N50A

International  
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Static @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)

|                                 | Parameter                            | Min. | Typ. | Max. | Units               | Conditions                                            |
|---------------------------------|--------------------------------------|------|------|------|---------------------|-------------------------------------------------------|
| $V_{(BR)DSS}$                   | Drain-to-Source Breakdown Voltage    | 500  | —    | —    | V                   | $V_{GS} = 0V, I_D = 250\mu A$                         |
| $\Delta V_{(BR)DSS}/\Delta T_J$ | Breakdown Voltage Temp. Coefficient  | —    | 0.55 | —    | V/ $^\circ\text{C}$ | Reference to $25^\circ\text{C}, I_D = 1\text{mA}$ ④   |
| $R_{DS(on)}$                    | Static Drain-to-Source On-Resistance | —    | —    | 0.23 | $\Omega$            | $V_{GS} = 10V, I_D = 13A$ ④                           |
| $V_{GS(th)}$                    | Gate Threshold Voltage               | 2.0  | —    | 4.0  | V                   | $V_{DS} = V_{GS}, I_D = 250\mu A$                     |
| $I_{DSS}$                       | Drain-to-Source Leakage Current      | —    | —    | 25   | $\mu A$             | $V_{DS} = 500V, V_{GS} = 0V$                          |
|                                 |                                      | —    | —    | 250  |                     | $V_{DS} = 400V, V_{GS} = 0V, T_J = 125^\circ\text{C}$ |
| $I_{GSS}$                       | Gate-to-Source Forward Leakage       | —    | —    | 100  | nA                  | $V_{GS} = 30V$                                        |
|                                 | Gate-to-Source Reverse Leakage       | —    | —    | -100 |                     | $V_{GS} = -30V$                                       |

Dynamic @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)

|                        | Parameter                       | Min. | Typ. | Max. | Units | Conditions                                      |
|------------------------|---------------------------------|------|------|------|-------|-------------------------------------------------|
| $g_{fs}$               | Forward Transconductance        | 12   | —    | —    | S     | $V_{DS} = 50V, I_D = 13A$                       |
| $Q_g$                  | Total Gate Charge               | —    | —    | 120  | nC    | $I_D = 22A$                                     |
| $Q_{gs}$               | Gate-to-Source Charge           | —    | —    | 32   |       | $V_{DS} = 400V$                                 |
| $Q_{gd}$               | Gate-to-Drain ("Miller") Charge | —    | —    | 52   |       | $V_{GS} = 10V$ , See Fig. 6 and 13 ④            |
| $t_{d(on)}$            | Turn-On Delay Time              | —    | 26   | —    | ns    | $V_{DD} = 250V$                                 |
| $t_r$                  | Rise Time                       | —    | 94   | —    |       | $I_D = 22A$                                     |
| $t_{d(off)}$           | Turn-Off Delay Time             | —    | 47   | —    |       | $R_G = 4.3\Omega$                               |
| $t_f$                  | Fall Time                       | —    | 47   | —    |       | $R_D = 11\Omega$ , See Fig. 10 ④                |
| $C_{iss}$              | Input Capacitance               | —    | 3450 | —    | pF    | $V_{GS} = 0V$                                   |
| $C_{oss}$              | Output Capacitance              | —    | 513  | —    |       | $V_{DS} = 25V$                                  |
| $C_{rss}$              | Reverse Transfer Capacitance    | —    | 27   | —    |       | $f = 1.0\text{MHz}$ , See Fig. 5                |
| $C_{oss}$              | Output Capacitance              | —    | 4935 | —    |       | $V_{GS} = 0V, V_{DS} = 1.0V, f = 1.0\text{MHz}$ |
| $C_{oss}$              | Output Capacitance              | —    | 137  | —    |       | $V_{GS} = 0V, V_{DS} = 400V, f = 1.0\text{MHz}$ |
| $C_{oss \text{ eff.}}$ | Effective Output Capacitance    | —    | 264  | —    |       | $V_{GS} = 0V, V_{DS} = 0V \text{ to } 400V$ ⑤   |

## Avalanche Characteristics

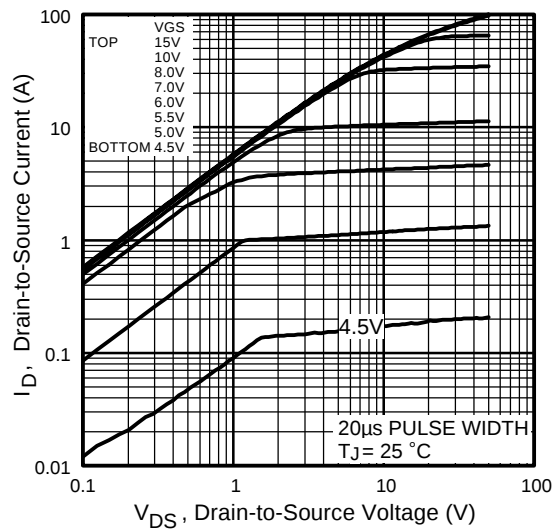
|          | Parameter                      | Typ. | Max. | Units |
|----------|--------------------------------|------|------|-------|
| $E_{AS}$ | Single Pulse Avalanche Energy② | —    | 1180 | mJ    |
| $I_{AR}$ | Avalanche Current①             | —    | 22   | A     |
| $E_{AR}$ | Repetitive Avalanche Energy①   | —    | 28   | mJ    |

## Thermal Resistance

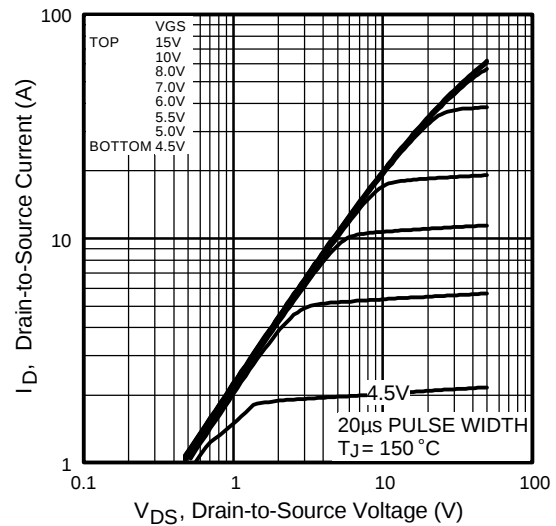
|                 | Parameter                           | Typ. | Max. | Units              |
|-----------------|-------------------------------------|------|------|--------------------|
| $R_{\theta JC}$ | Junction-to-Case                    | —    | 0.45 | $^\circ\text{C/W}$ |
| $R_{\theta CS}$ | Case-to-Sink, Flat, Greased Surface | 0.24 | —    |                    |
| $R_{\theta JA}$ | Junction-to-Ambient                 | —    | 40   |                    |

## Diode Characteristics

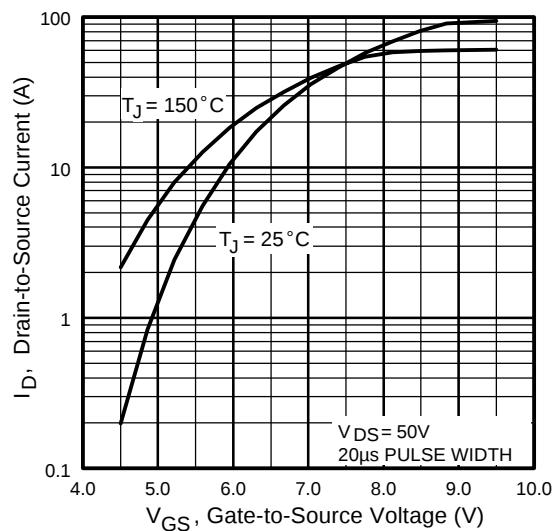
|          | Parameter                              | Min.                                                                        | Typ. | Max. | Units         | Conditions                                                     |
|----------|----------------------------------------|-----------------------------------------------------------------------------|------|------|---------------|----------------------------------------------------------------|
| $I_S$    | Continuous Source Current (Body Diode) | —                                                                           | —    | 22   | A             | MOSFET symbol showing the integral reverse p-n junction diode. |
| $I_{SM}$ | Pulsed Source Current (Body Diode) ①   | —                                                                           | —    | 88   |               |                                                                |
| $V_{SD}$ | Diode Forward Voltage                  | —                                                                           | —    | 1.5  | V             | $T_J = 25^\circ\text{C}, I_S = 22A, V_{GS} = 0V$ ④             |
| $t_{rr}$ | Reverse Recovery Time                  | —                                                                           | 570  | 850  | ns            | $T_J = 25^\circ\text{C}, I_F = 22A$                            |
| $Q_{rr}$ | Reverse Recovery Charge                | —                                                                           | 6.1  | 9.2  | $\mu\text{C}$ | $di/dt = 100A/\mu\text{s}$ ④                                   |
| $t_{on}$ | Forward Turn-On Time                   | Intrinsic turn-on time is negligible (turn-on is dominated by $L_S + L_D$ ) |      |      |               |                                                                |



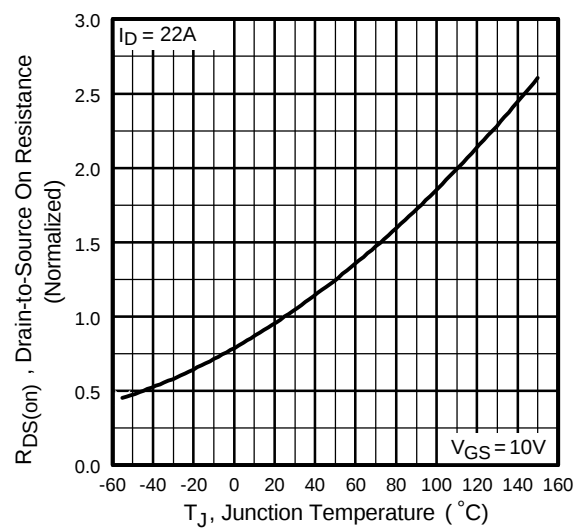
**Fig 1.** Typical Output Characteristics



**Fig 2.** Typical Output Characteristics



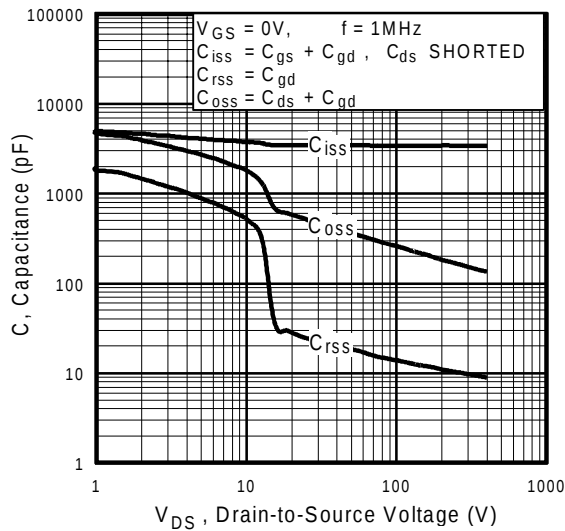
**Fig 3.** Typical Transfer Characteristics



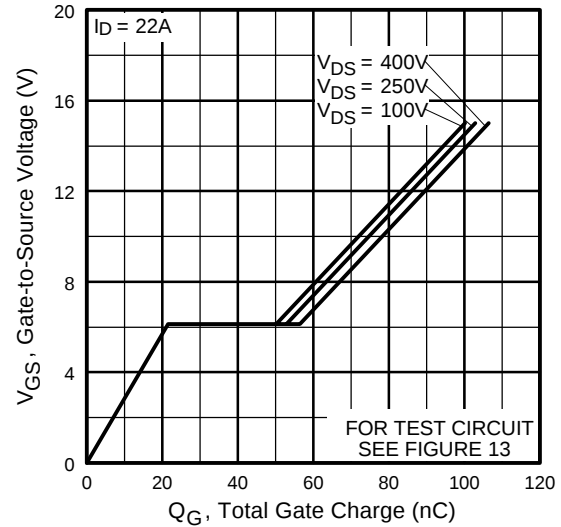
**Fig 4.** Normalized On-Resistance Vs. Temperature

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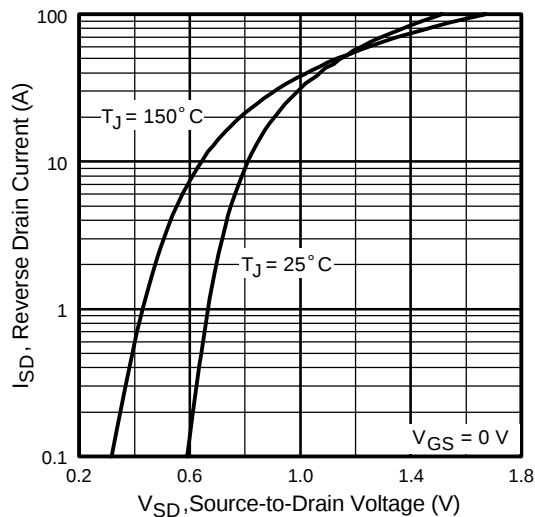
International  
**IR** Rectifier



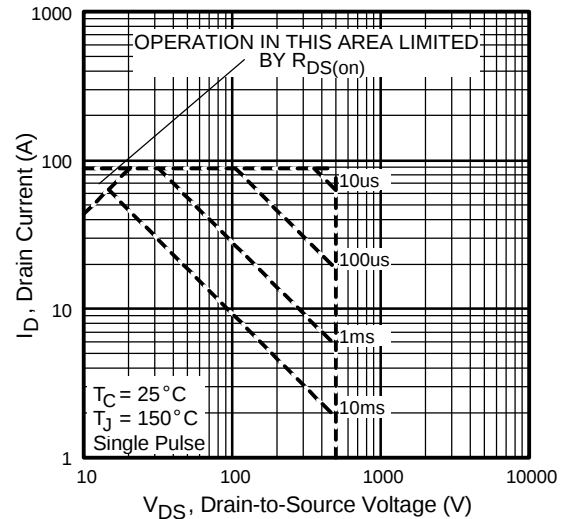
**Fig 5.** Typical Capacitance Vs. Drain-to-Source Voltage



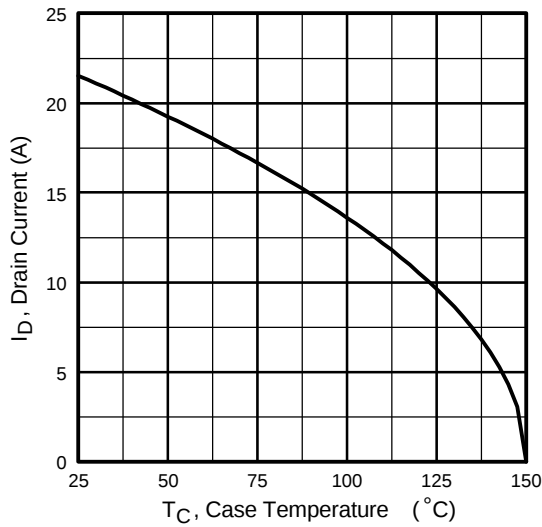
**Fig 6.** Typical Gate Charge Vs. Gate-to-Source Voltage



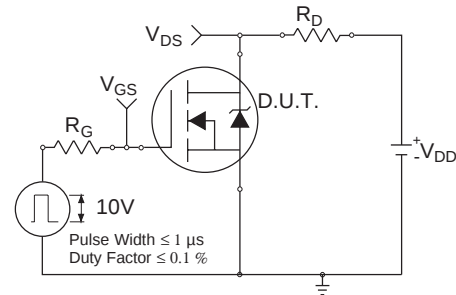
**Fig 7.** Typical Source-Drain Diode Forward Voltage



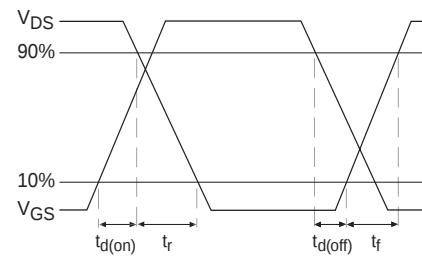
**Fig 8.** Maximum Safe Operating Area



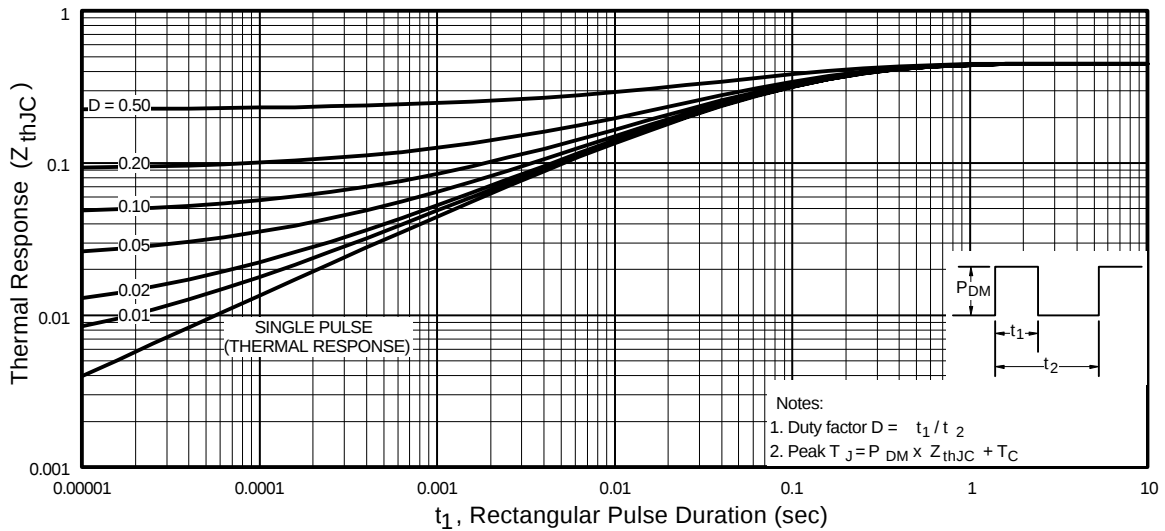
**Fig 9.** Maximum Drain Current Vs. Case Temperature



**Fig 10a.** Switching Time Test Circuit



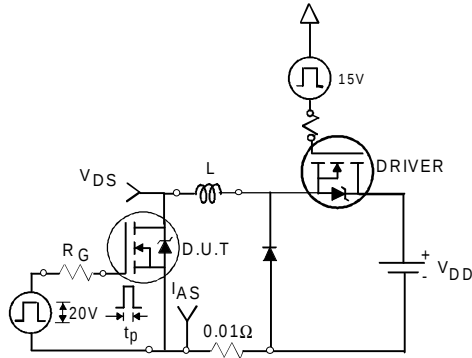
**Fig 10b.** Switching Time Waveforms



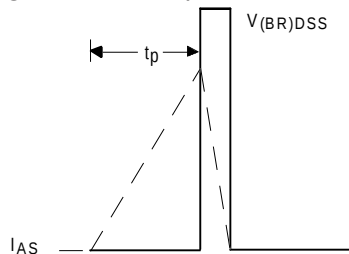
**Fig 11.** Maximum Effective Transient Thermal Impedance, Junction-to-Case

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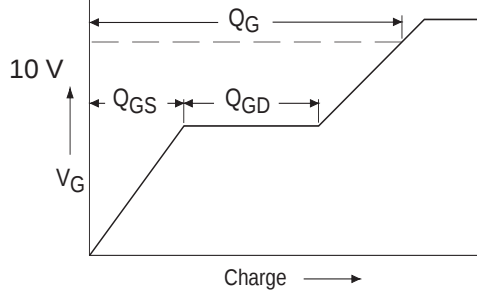
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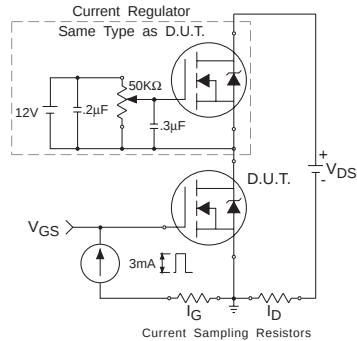
**Fig 12a.** Unclamped Inductive Test Circuit



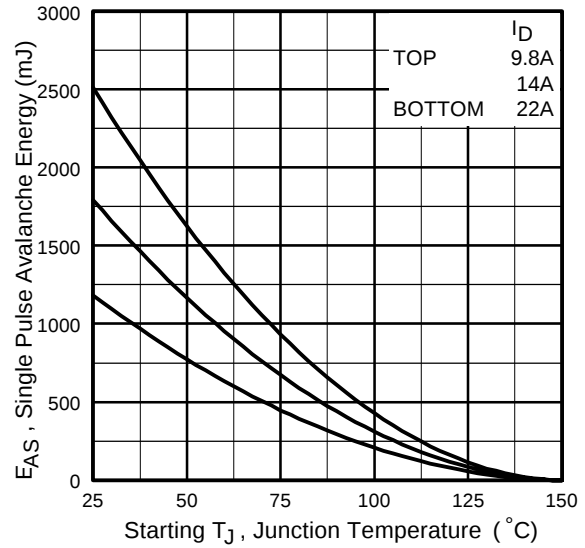
**Fig 12b.** Unclamped Inductive Waveforms



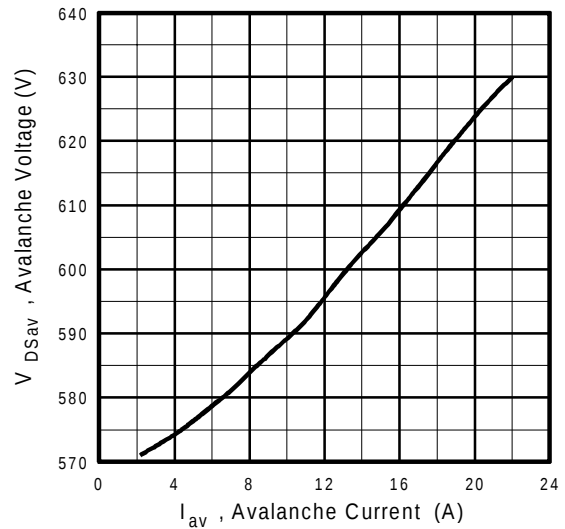
**Fig 13a.** Basic Gate Charge Waveform



**Fig 13b.** Gate Charge Test Circuit



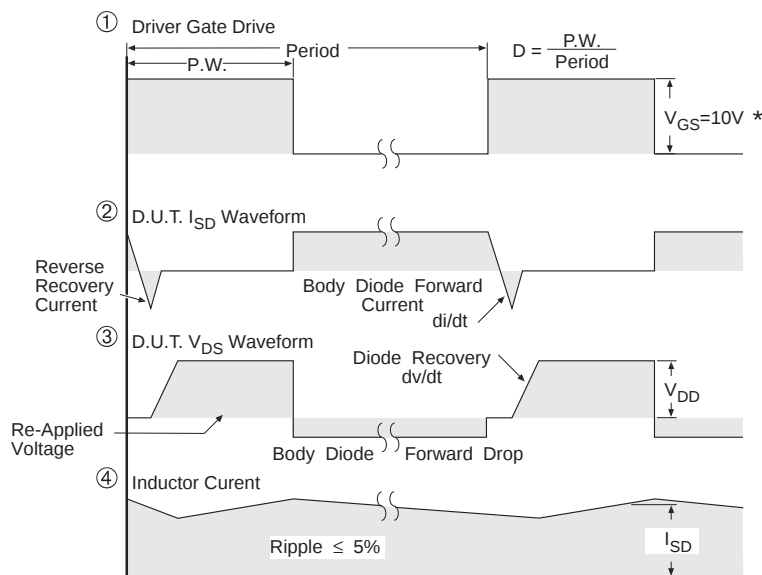
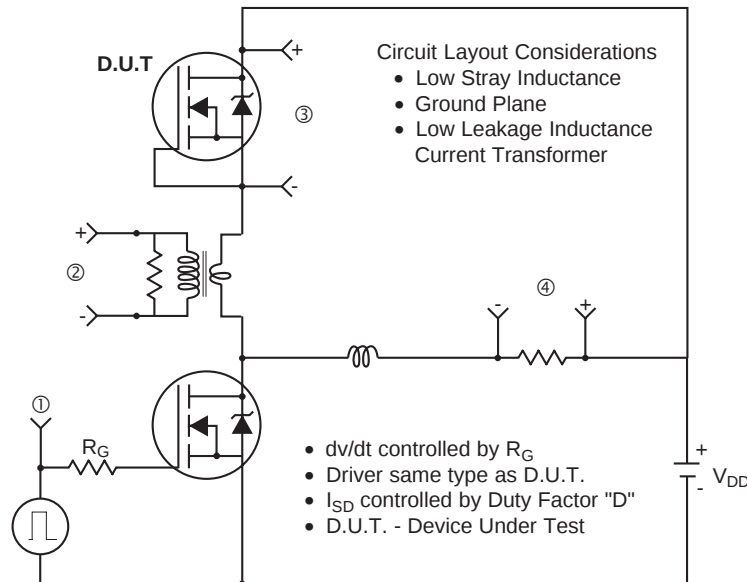
**Fig 12c.** Maximum Avalanche Energy Vs. Drain Current



**Fig 12d.** Typical Drain-to-Source Voltage Vs. Avalanche Current

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## Peak Diode Recovery $dv/dt$ Test Circuit



\*  $V_{GS} = 5V$  for Logic Level Devices

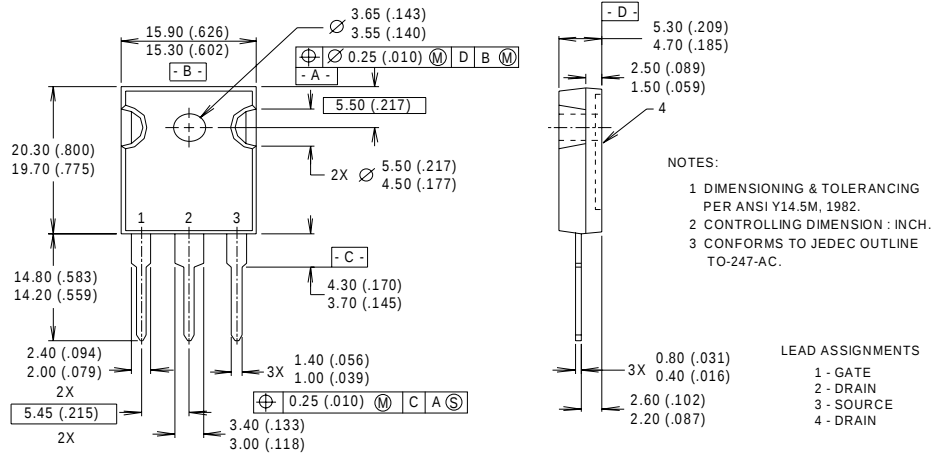
**Fig 14.** For N-Channel HEXFET® Power MOSFETs

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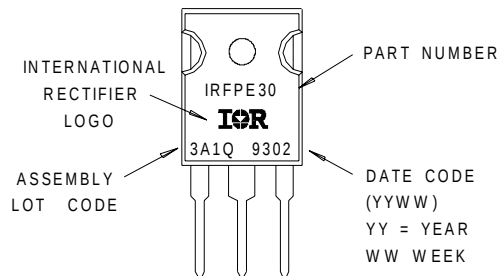
## TO-247AC Package Outline

Dimensions are shown in millimeters (inches)



## TO-247AC Part Marking Information

EXAMPLE : THIS IS AN IRFPE30  
WITH ASSEMBLY  
LOT CODE 3A1Q



### Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- ② Starting  $T_J = 25^\circ\text{C}$ ,  $L = 4.87\text{mH}$ ,  $R_G = 25\Omega$ ,  $I_{AS} = 22\text{A}$ . (See Figure 12a)
- ③  $I_{SD} \leq 22\text{A}$ ,  $di/dt \leq 190\text{A}/\mu\text{s}$ ,  $V_{DD} \leq V_{(BR)DSS}$ ,  $T_J \leq 150^\circ\text{C}$
- ④ Pulse width  $\leq 300\mu\text{s}$ ; duty cycle  $\leq 2\%$ .
- ⑤  $C_{OSS}$  eff. is a fixed capacitance that gives the same charging time as  $C_{OSS}$  while  $V_{DS}$  is rising from 0 to 80%  $V_{DSS}$

International  
**IR** Rectifier

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*Data and specifications subject to change without notice. 12/99*